

(0.635 mm) .025" PITCH • QTS/QSS SERIES

### **QTS Board Mates:**

OSS

QSS **Board Mates:** 

QTS/QSS Cable Mates:

SQCD

Standoffs: SO

## **SPECIFICATIONS**

Insulator Material: Liquid Crystal Polymer Contact Material: Phosphor Bronze Phosphor Biolize Plating: Au or Sn over 50 µ" (1.27 µm) Ni Current Rating: Contact: 1.8 A per pin (2 pins powered) **Ground Plane:** 23.1 A per ground plane (1 ground plane powered) Operating Temp Range: -55 °C to +125 °C Voltage Rating: 285 VAC Max Cycles:

#### NO. OF POSITIONS LEAD QTS **PLATING OPTION STYLE PER ROW** Specify -025, -050, -F LEAD = Gold flash on contact, Matte Tin -075 (50 total positions per bank) **STYLE** on tail

from

Chart

=  $10 \mu$ " (0.25  $\mu$ m) Gold on contact, Matte Tin on tail

= 50 μ" (1.27 mm) Electro-Polished Selective Gold on contact, Matte Tin on tail (passes 10 year MFG testing)

-K = (7.00 mm) .275" DIA Polyimide film Pick & Place Pad

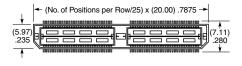
**OTHER** 

**OPTIONS** 

-TR = Tape & Reel

-FR

Full Reel Tape & Reel (must order maximum quantity per reel; contact Samtec for quantity breaks)







View complete specifications at: samtec.com?QTS

QTS LEAD STYLE	A	MATED HEIGHT WITH QSS
-01	(4.27) .168	(5.00) .197
-02	(7.26) .286	(8.00) .315

\*Processing conditions will affect mated height. See SO Series for board space tolerances

# **PROCESSING**

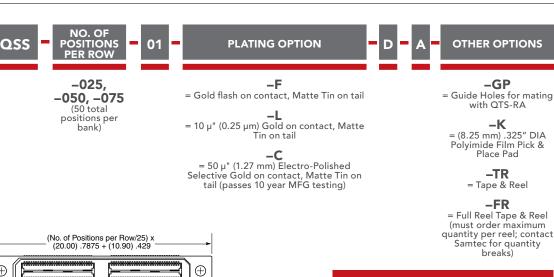
Lead-Free Solderable:

QTS SMT Lead Coplanarity: (0.10 mm) .004" max

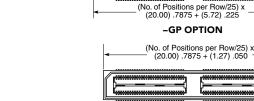
QSS SMT Lead Coplanarity: (0.10 mm) .004" max (025-050) (0.15 mm) .006" max (075)\* \*(.004" stencil solution

may be available; contact ipg@samtec.com)
Board Stacking:

For applications requiring more than two connectors contact ipg@samtec.com







See pg 46-47 for Right-Angle & Edge Mount options.



View complete specifications at: samtec.com?QSS

(7.49) .295

### Note:

Some lengths, styles and options are non-standard, non-returnable.